



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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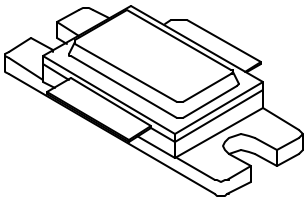
Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China





1214-150L

150 Watts, 36 Volts, 5 ms, 20%
Radar 1200 to 1400 MHz

GENERAL DESCRIPTION	CASE OUTLINE 55ST-1
<p>The 1214-150L is an internally matched, COMMON BASE transistor capable of providing 150 Watts of pulsed RF output power at 5 milliseconds pulse width, 20% duty factor across the band 1200 to 1400 MHz. This hermetically solder-sealed transistor is specifically designed for L-Band radar applications. It utilizes gold metallization and diffused emitter ballasting to provide high reliability and supreme ruggedness.</p> <p>ABSOLUTE MAXIMUM RATINGS</p> <p>Maximum Power Dissipation Device Dissipation @25°C¹ 320 W</p> <p>Maximum Voltage and Current Collector to Base Voltage (BV_{ces}) 70 V Emitter to Base Voltage (BV_{ebo}) 3.5 V Collector Current (I_c) 15 A</p> <p>Maximum Temperatures Storage Temperature -65 to +200 °C Operating Junction Temperature +200 °C</p>	

ELECTRICAL CHARACTERISTICS @ 25°C

SYMBOL	CHARACTERISTICS	TEST CONDITIONS	MIN	TYP	MAX	UNITS
P _{out}	Power Output	F = 1200-1400 MHz	140	150	200	W
P _g	Power Gain	V _{cc} = 36 Volts	7.15		8.7	dB
η _c	Collector Efficiency	Pin = 27 W	45			%
R _L	Return Loss	Pulse Width = 5 mS	-9			dB
P _d	Pulse Droop	Duty Factor = 20%			0.5	dB
VSWR ¹	Load Mismatch Tolerance	F=1200 MHz, Pin = 27W			3.0:1	

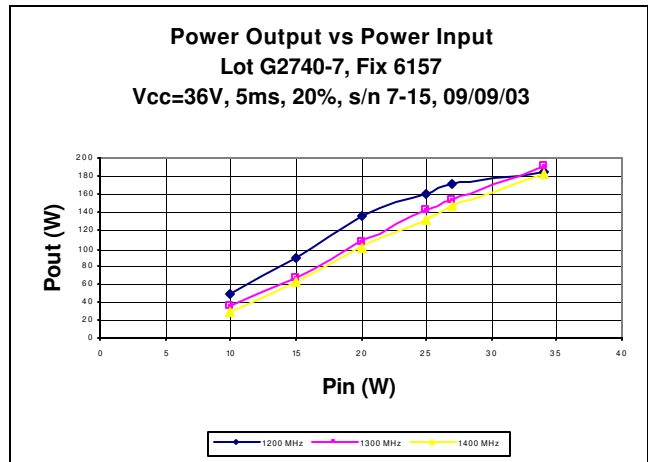
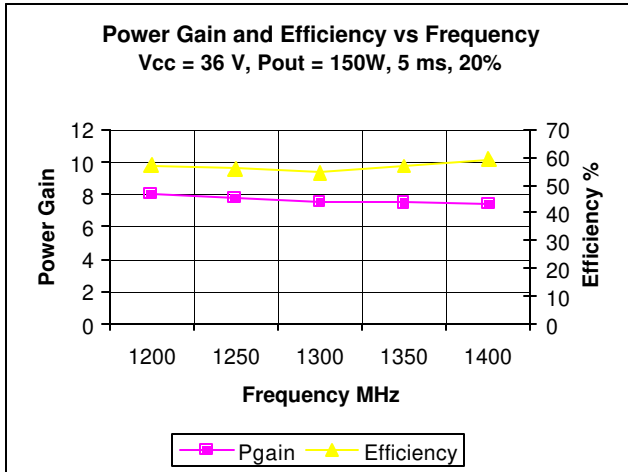
FUNCTIONAL CHARACTERISTICS @ 25°C

BV _{ebo}	Emitter to Base Breakdown	I _c = 50 mA	3.0			V
BV _{ces}	Collector to Emitter Breakdown	I _c = 100 mA	65			V
h _{FE}	DC – Current Gain	V _{ce} = 5V, I _c = 1A	20	55		
θ _{jc} ¹	Thermal Resistance				0.55	°C/W

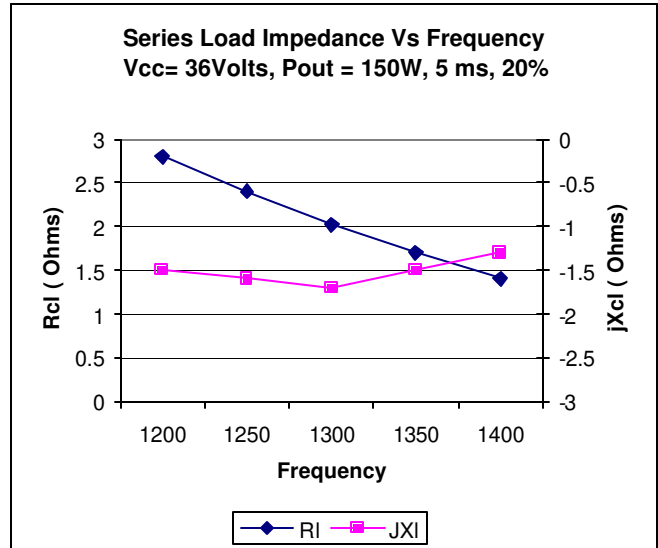
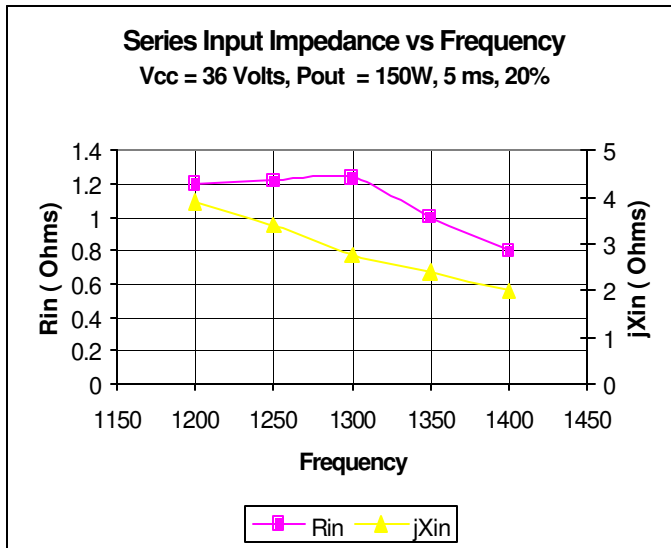
NOTES: 1. Pulse condition of 5 mS, 20%

April 2005

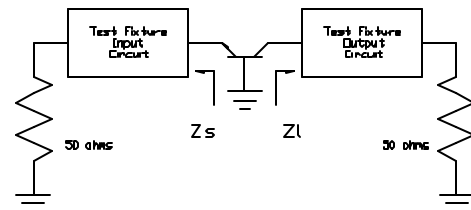
Performance Curves



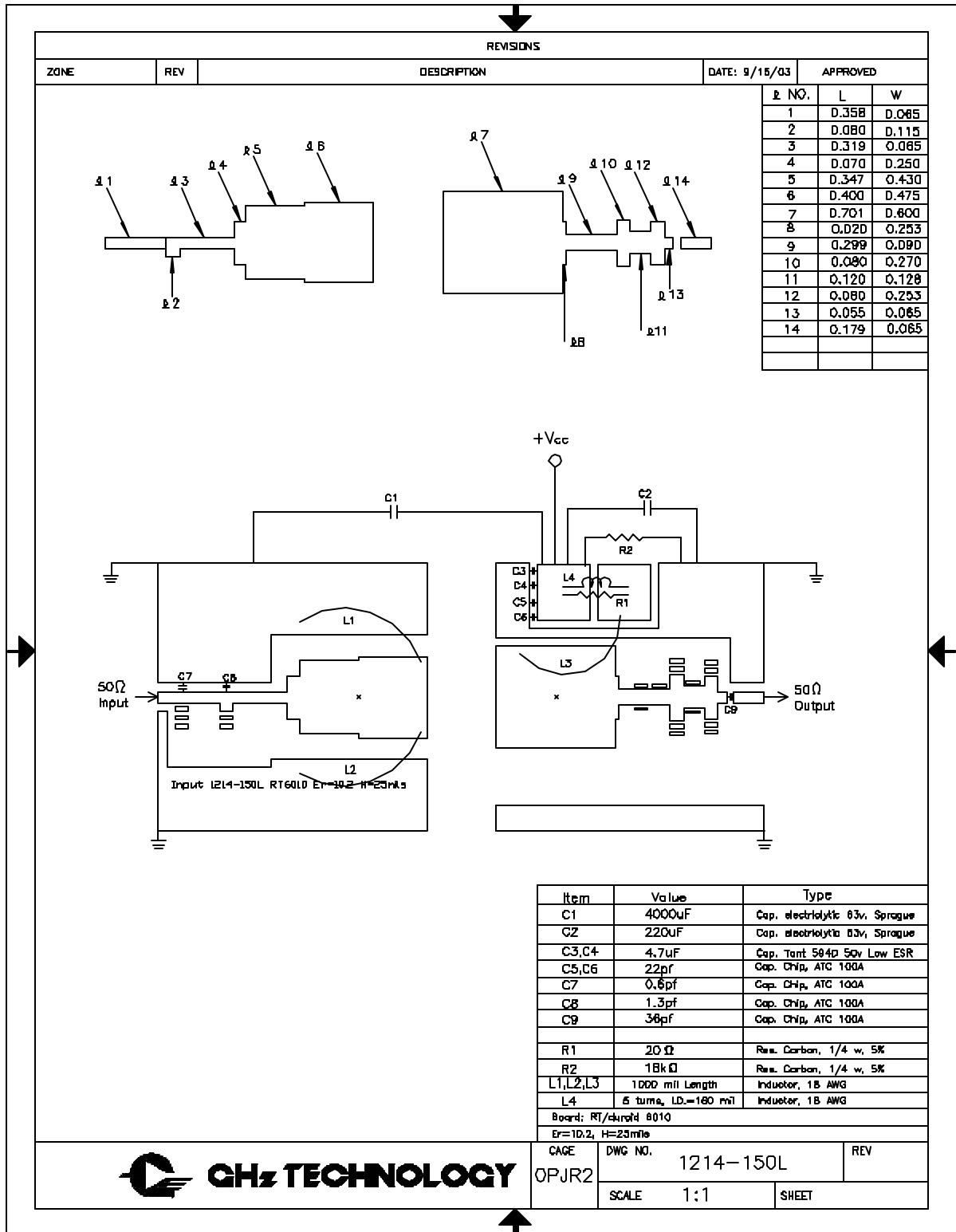
Typical Impedances

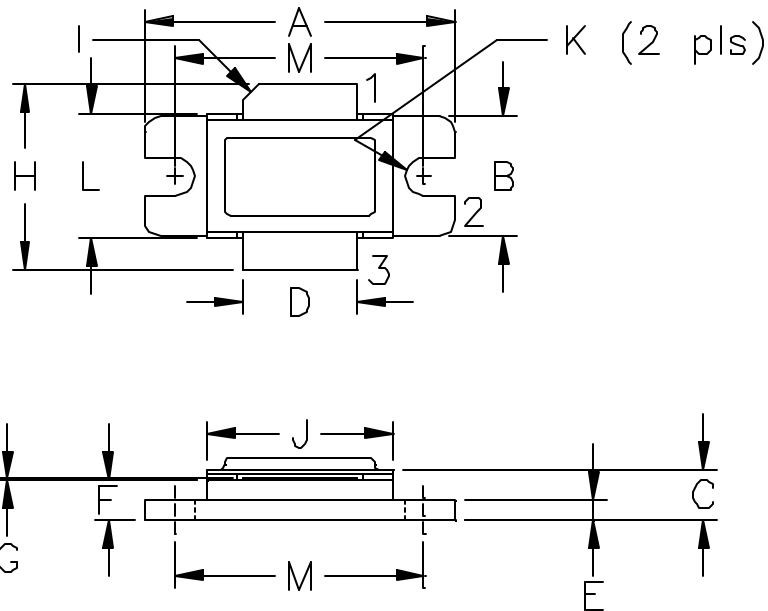


Impedance		
Freq	Zs	Zl
1200	3.9-j1.2	2.8-j1.5
1300	2.77-j1.24	2.02-j1.7
1400	2.0-j0.8	2.02-j1.7



1214-150L

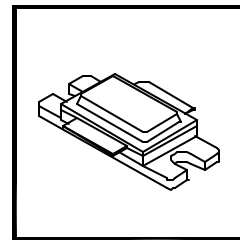




DIM	MILLIMETER	±TOL	INCHES	±TOL
A	25.40	.25	1.000	.010
B	9.78	.25	.385	.010
C	4.00	.19	.142	.007
D	9.40	.13	.370	.005
E	1.53	.13	.060	.005
F	3.18	.13	.125	.005
G	0.08	+0/-0.00	.003	+0.002/-0.000
H	19.05	0.51	.750	.020
I	45°	5°	45°	5°
J	15.24	.25	.600	.010
K	3.05 DIA	.13	.120 DIA	.005
L	10.15	.13	.400	.005
M	20.32	.25	.800	.010

STYLE 1:
PIN 1 = COLLECTOR
2 = BASE
3 = EMITTER

STYLE 2:
PIN 1 = COLLECTOR
2 = EMITTER
3 = BASE



GHZ TECHNOLOGY
 RF - MICROWAVE SILICON POWER TRANSISTORS

DWG NO.

55ST